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Nakamura

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(54) **LAMINATED POLISHING PAD AND METHOD FOR PRODUCING SAME**

(58) **Field of Classification Search**
CPC B24B 37/005; B24B 37/22; B32B 3/10
See application file for complete search history.

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(57) **ABSTRACT**

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A method for manufacturing a laminated polishing pad of the present invention, comprising the steps of: forming a polishing layer by providing a light transmitting region in an opening A of a polishing region; providing an adhesive member X on one side of the polishing layer, wherein the adhesive member X contains a hot-melt adhesive; providing a removable protective member on a part of the adhesive member X corresponding to the light transmitting region; bonding a support layer to the adhesive member X on which the removable protective member is provided; and removing a part of the support layer corresponding to the light trans-

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